Vishay Semiconductors

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Hyperfast Rectifier, 2 x 15 FRED Pt[®]



Common cathode 63 1ó Anode Anode VS-30CTH02FP-N3

PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 x 15 A			
V _R	200 V			
V _F at I _F	0.78 V			
t _{rr} typ.	See Recovery table			
T _J max.	175 °C			
Package	TO-220 FullPAK 3L			
Circuit configuration	Common cathode			

FEATURES

- Hyperfast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- Fully isolated package (V_{INS} = 2500 V_{RMS})
- UL pending
- Designed and gualified according to JEDEC[®]-JESD 47
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION / APPLICATIONS

200 V series are the state of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage		V _{RRM}		200	V
Average restified forward ourrest	per diode	I _{F(AV)}	T _C = 125 °C	15	
Average rectified forward current per d				30	А
Non-repetitive peak surge current		I _{FSM}	$T_J = 25 \ ^\circ C$	200	
Operating junction and storage temperation	atures	T _J , T _{Stg}		-65 to +175	°C

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-		
	M	I _F = 15 A	-	0.92	1.05	V	
Forward voltage V _F		I _F = 15 A, T _J = 125 °C	-	0.78	0.85		
Deverse leekege eurrent		$V_{R} = V_{R}$ rated	-	-	10		
Reverse leakage current		$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	5	300	μΑ	
Junction capacitance	CT	V _R = 200 V	-	57	-	pF	
Series inductance	L _S	Measured lead to lead 5 mm from package body	-	8	-	nH	

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DYNAMIC RECOVERY CHARACTERISTICS (T _C = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	-	35	
Reverse recovery time	+	$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	-	30	
Reverse recovery time t _{rr}	۲r	T _J = 25 °C		-	26	-	ns
		T _J = 125 °C	$I_F = 15 A$		-	40	-
Deals receivers ourrent		T _J = 25 °C	dl _F /dt = 200 A/µs V _B = 160 V	-	2.8	-	А
Peak recovery current I _{RRM}	T _J = 125 °C		-	6.0	-		
		T _J = 25 °C		-	37	-	nC
Reverse recovery charge	Reverse recovery charge Q _{rr}		T _J = 125 °C		120	-	no

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C
Thermal resistance, junction-to-case per diode	R _{thJC}	Mounting surface, flat, smooth and greased	-	-	3.5	°C/W
Marking device		Case style TO-220 FullPAK 3L		30CTI	H02FP	

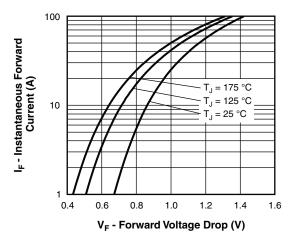


Fig. 1 - Typical Forward Voltage Drop Characteristics

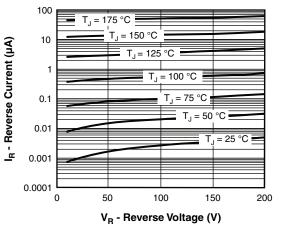


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

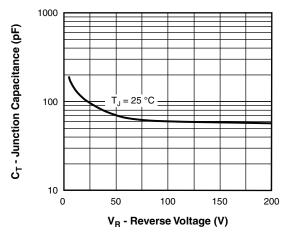


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

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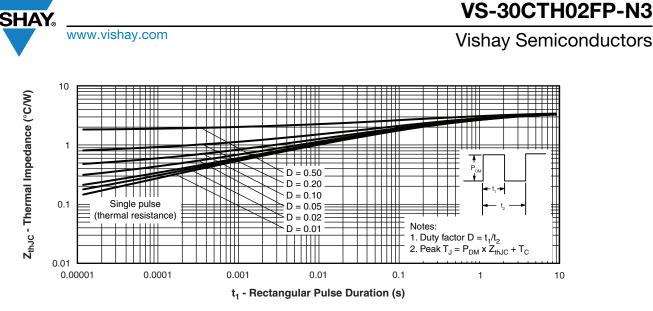


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

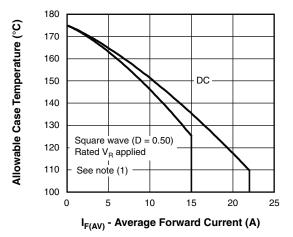


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

Note

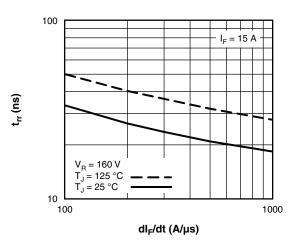


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

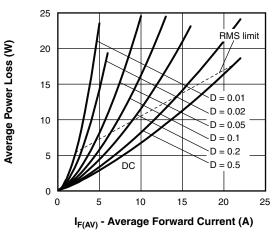


Fig. 6 - Forward Power Loss Characteristics

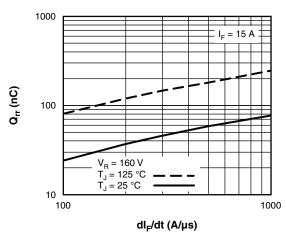


Fig. 8 - Typical Stored Charge vs. dl_F/dt

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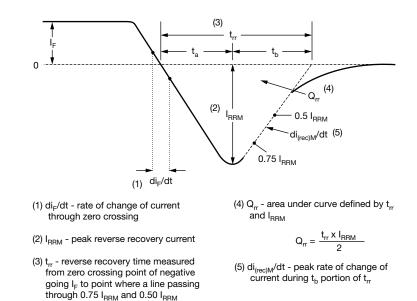
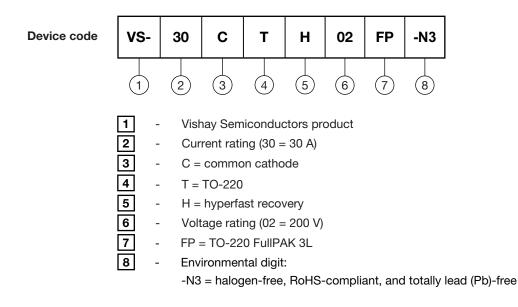


Fig. 9 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

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extrapolated to zero current.

ORDERING INFORMATION (Example)				
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION	
VS-20CTH03FP-N3	50	1000	Antistatic plastic tube	

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?96155				
Part marking information www.vishay.com/doc?95456				

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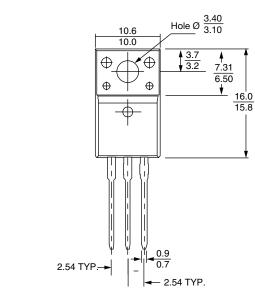
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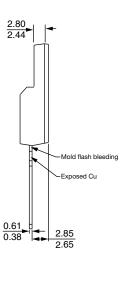


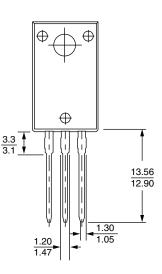
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3L TO-220 FullPAK

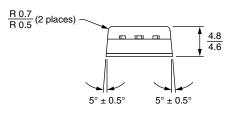
DIMENSIONS in millimeters







Bottom view



Notes

- ⁽¹⁾ All dimensions are in mm
- ⁽²⁾ Package body size exclude mold flash and burrs. Moldflash should be less than 6 mils



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